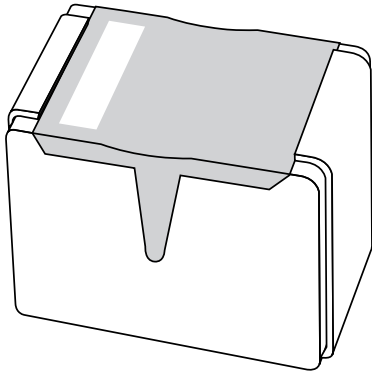


DATA SHEET



BAS216

High-speed switching diode

Product specification
Supersedes data of 1996 Apr 03

1999 Apr 22

High-speed switching diode

BAS216

FEATURES

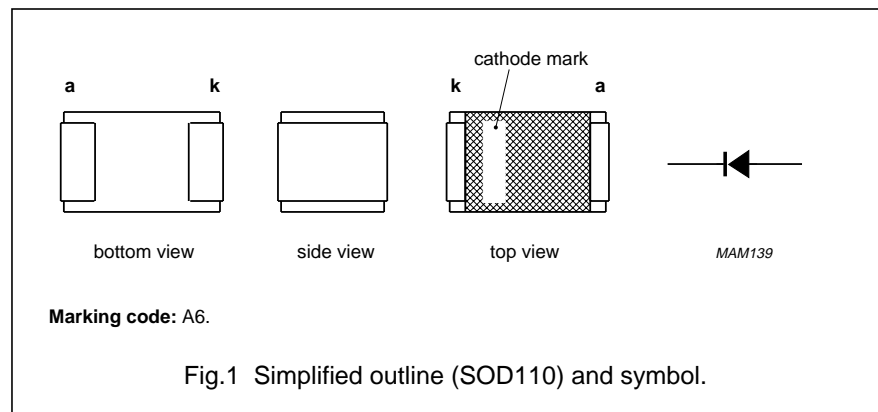
- Small ceramic SMD package
- High switching speed: max. 4 ns
- Continuous reverse voltage: max. 75 V
- Repetitive peak reverse voltage: max. 85 V
- Repetitive peak forward current: max. 500 mA.

APPLICATIONS

- High-speed switching in e.g. surface mounted circuits.

DESCRIPTION

The BAS216 is a high-speed switching diode fabricated in planar technology, and encapsulated in the small rectangular ceramic SMD SOD110 package.



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{RRM}	repetitive peak reverse voltage		–	85	V
V_R	continuous reverse voltage		–	75	V
I_F	continuous forward current	note 1	–	250	mA
I_{FRM}	repetitive peak forward current		–	500	mA
I_{FSM}	non-repetitive peak forward current	square wave; $T_j = 25\text{ °C}$ prior to surge; see Fig.4 $t = 1\ \mu\text{s}$ $t = 1\ \text{ms}$ $t = 1\ \text{s}$	–	4 1 0.5	A A A
P_{tot}	total power dissipation	$T_{amb} = 25\text{ °C}$; see Fig.2; note 1	–	400	mW
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C

Note

1. Device mounted on an FR4 printed-circuit board.

High-speed switching diode

BAS216

ELECTRICAL CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_F	forward voltage	see Fig.3			
		$I_F = 1\text{ mA}$	–	715	mV
		$I_F = 10\text{ mA}$	–	855	mV
		$I_F = 50\text{ mA}$	–	1	V
I_R	reverse current	$I_F = 150\text{ mA}$	–	1.25	V
		see Fig.5			
		$V_R = 25\text{ V}$	–	30	nA
		$V_R = 75\text{ V}$	–	1	μA
C_d	diode capacitance	$V_R = 25\text{ V}; T_j = 150\text{ }^\circ\text{C}$	–	30	μA
		$V_R = 75\text{ V}; T_j = 150\text{ }^\circ\text{C}$	–	50	μA
t_{rr}	reverse recovery time	$f = 1\text{ MHz}; V_R = 0$; see Fig.6	–	1.5	pF
V_{fr}	forward recovery voltage	when switched from $I_F = 10\text{ mA}$ to $I_R = 10\text{ mA}; R_L = 100\ \Omega$; measured at $I_R = 1\text{ mA}$; see Fig.7	–	4	ns
		when switched from $I_F = 10\text{ mA}$; $t_r = 20\text{ ns}$; see Fig.8	–	1.75	V

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-tp}$	thermal resistance from junction to tie-point		200	K/W
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	315	K/W

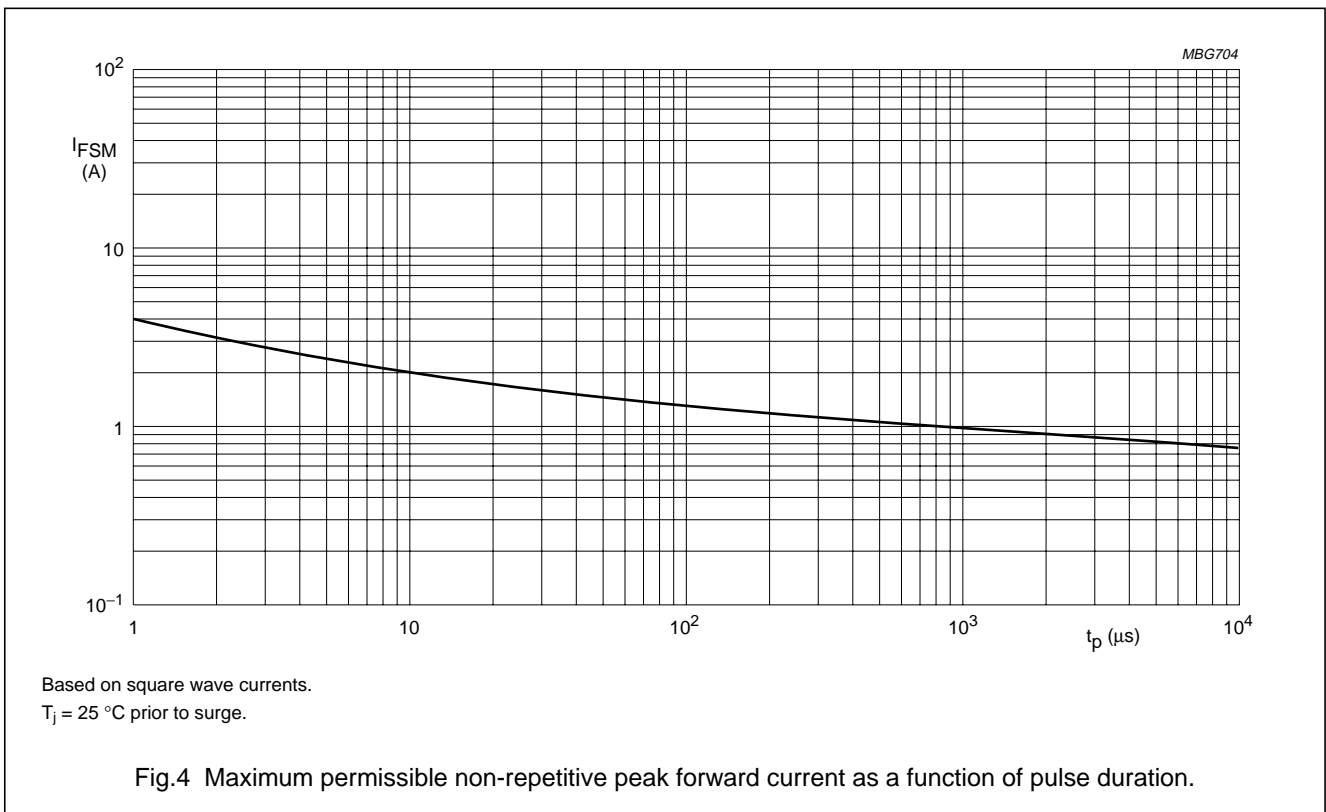
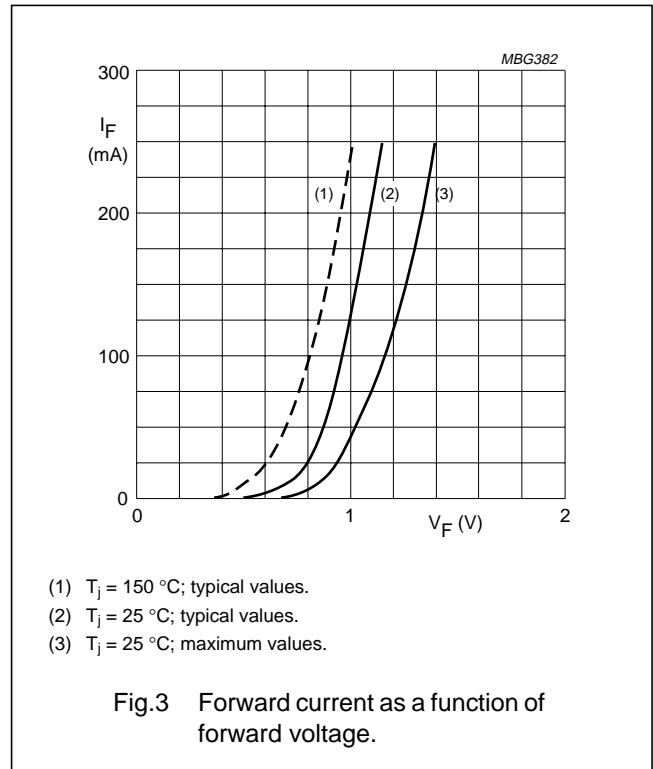
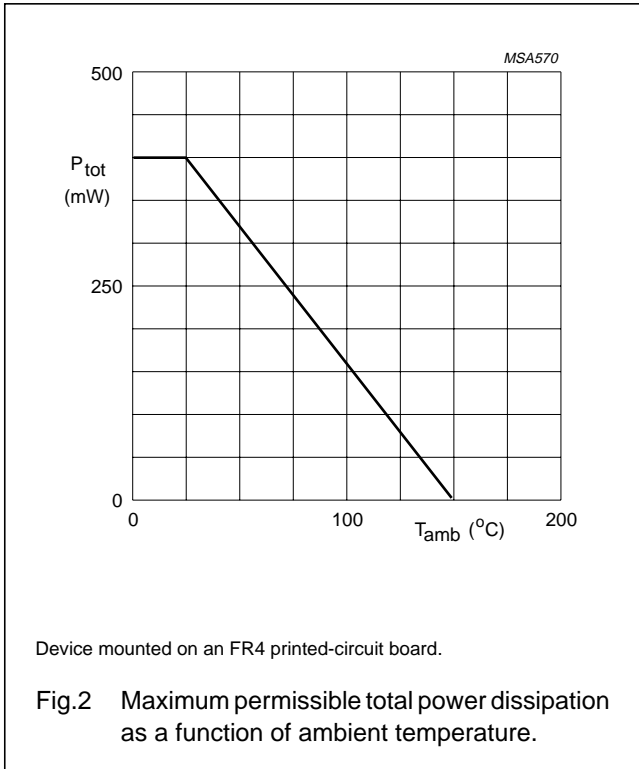
Note

1. Device mounted on an FR4 printed-circuit board.

High-speed switching diode

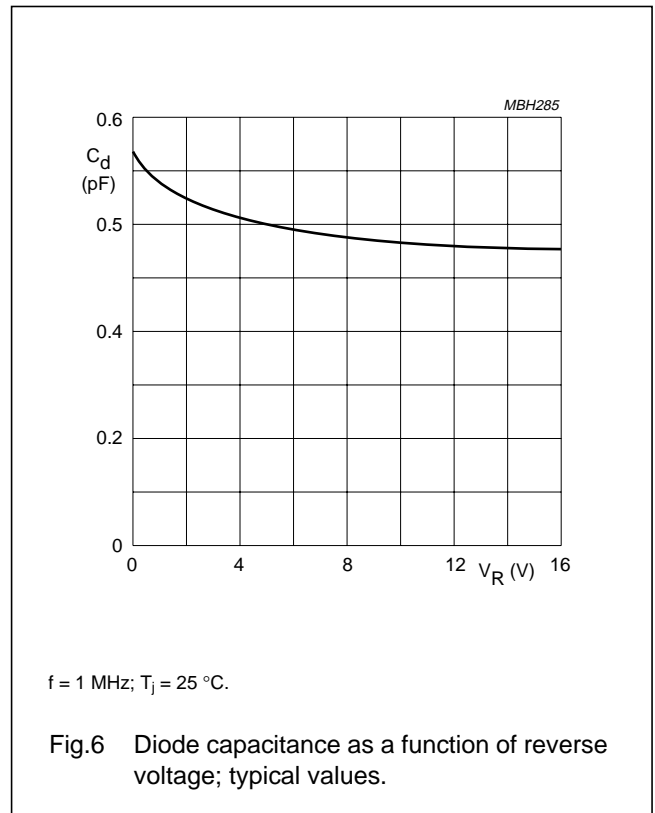
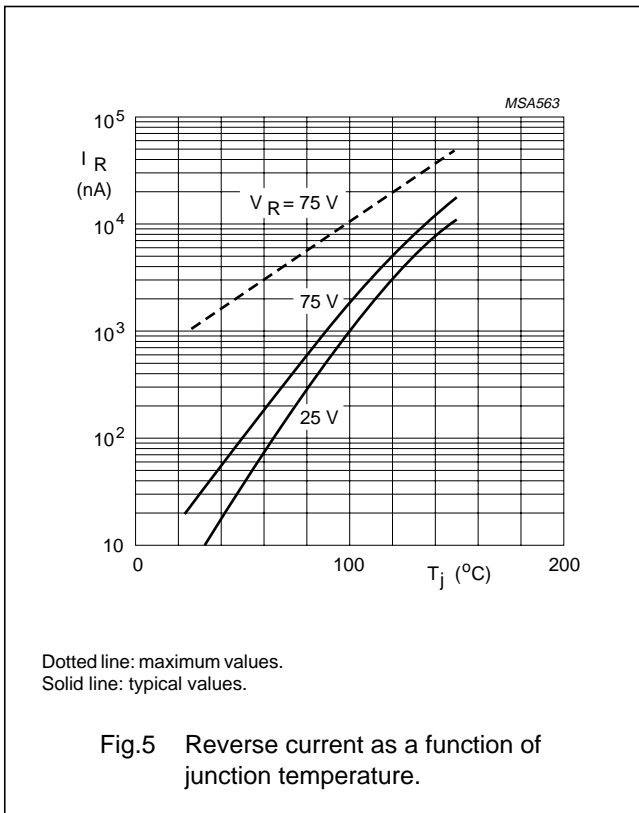
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GRAPHICAL DATA



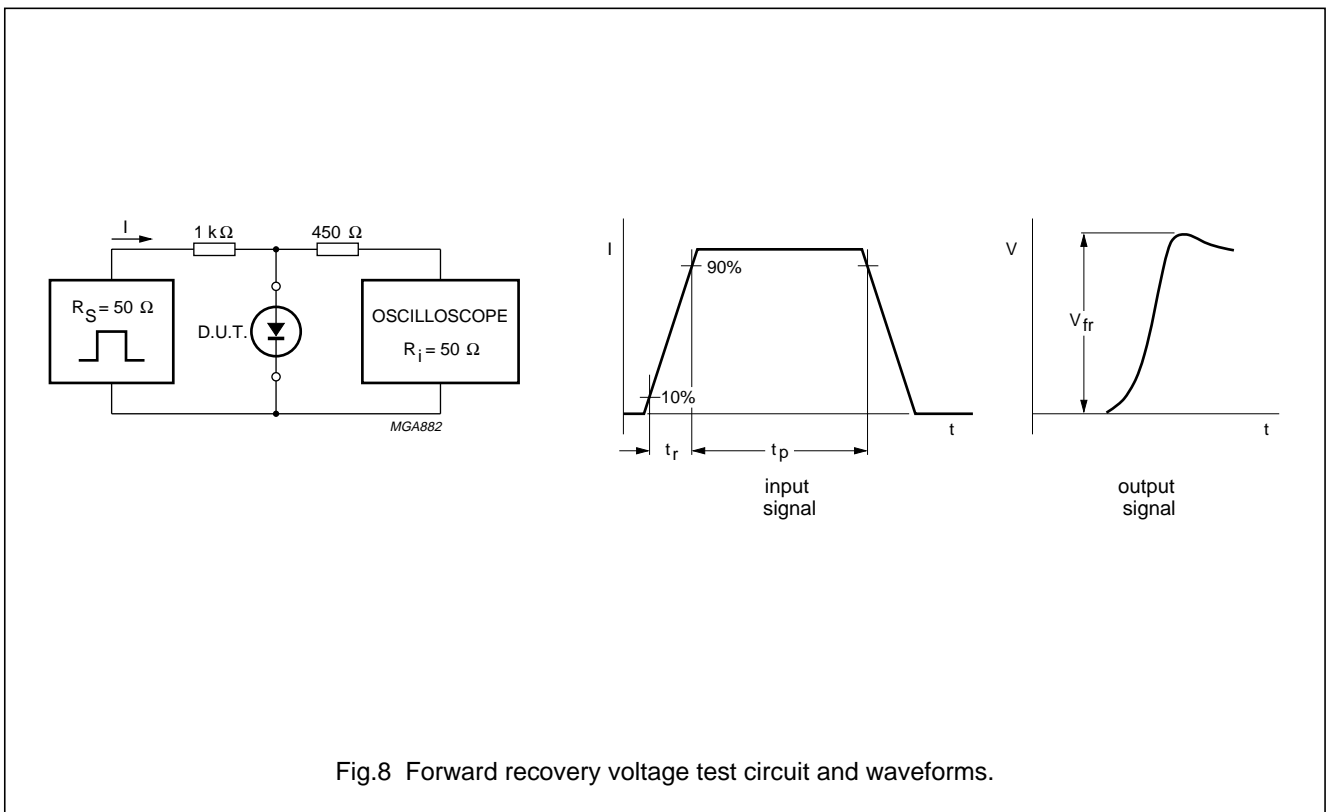
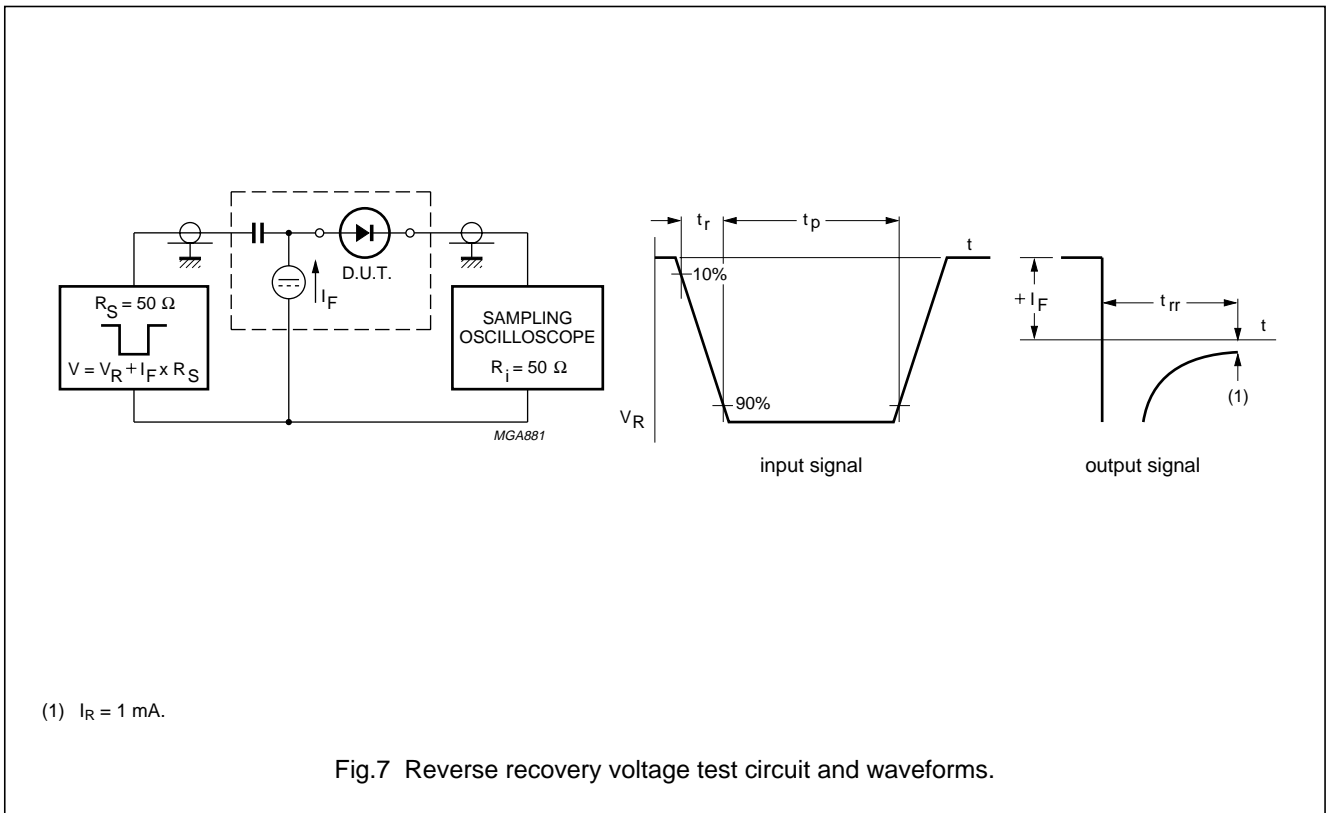
High-speed switching diode

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High-speed switching diode

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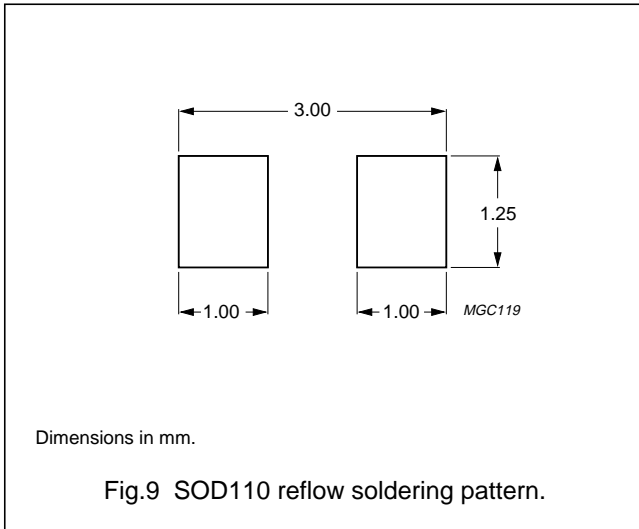
High-speed switching diode

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MOUNTING

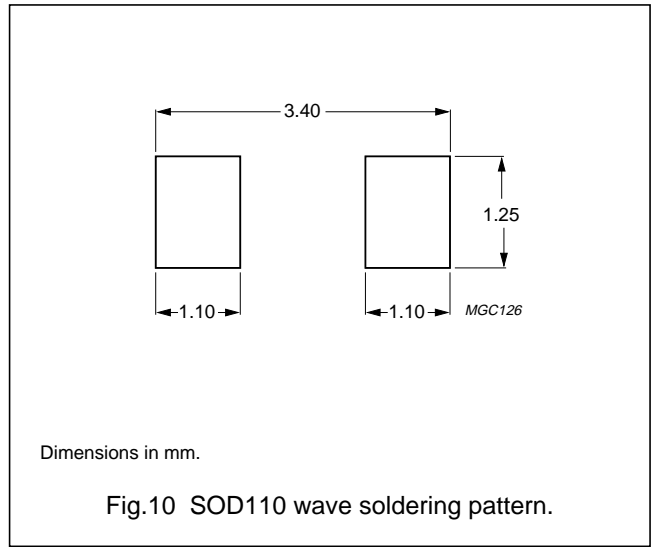
Reflow soldering

Follow standard reflow soldering techniques to ensure correct application of solder paste and placement of the SOD110 package (see Fig.9).



Wave soldering

Before wave soldering, attach SOD110 packages to the printed-circuit boards using a small dot of thermo-setting epoxy or UV-curing adhesive centred between the soldering lands (see Fig.10).



High-speed switching diode

BAS216

PACKAGE OUTLINE

Very small ceramic rectangular surface mounted package

SOD110

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	D	E	y
mm	1.6	2.10 1.90	1.40 1.10	0.1

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOD110					97-04-14

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

High-speed switching diode

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NOTES

High-speed switching diode

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NOTES

High-speed switching diode

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NOTES

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